

500mA, Low Dropout Linear Regulator with Shutdown

■ FEATURES

- · Active Low Shutdown Control.
- · Very Low Quiescent Current.
- Very Low Dropout Voltage of 650mV at 500mA Output Current (3.0V Output Version)
- 1.5V, 1.8V, 2.5V, 2.8V, 3.0V, 3.3V Output Voltage.
- Short Circuit and Thermal Protection.
- ±2% Output Tolerance.
- Miniature Package: SOT-23-5

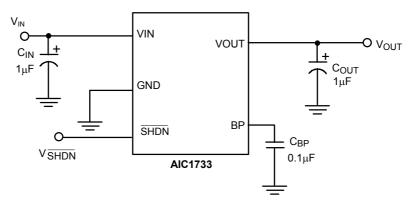
APPLICATIONS

- PDA
- DSC
- Notebook
- Pagers
- · Personal Communication Equipment
- · Cordless Telephones
- Portable Instrumentation
- Portable Consumer Equipment
- · Battery Powered Systems

DESCRIPTION

AIC1733 is a 500mA low noise, low dropout linear regulator, and is housed in small SOT-23-5 package. The device is in the "ON" state when the SHDN pin is set to logic high level. An internal P-MOSFET pass transistor is used to achieve 650mV low dropout voltage at 500mA load current. It offers high precision output voltage of ±2%. The quality of low quiescent current and low dropout voltage makes this device ideal for battery power applications. The internal reverse bias protection eliminates the requirement for a reverse voltage protection diode. The high ripple rejection and low noise of AIC1733 provide enhanced performance for critical applications. The noise bypass pin can be connected an external capacitor to reduce the output noise level.

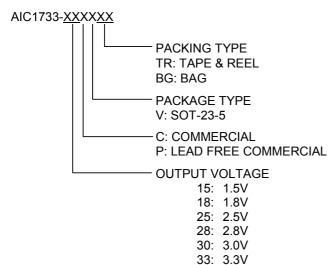
TYPICAL APPLICATION CIRCUIT

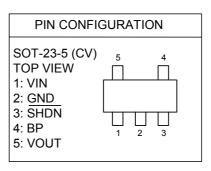


Low Noise Low Dropout Linear Regulator



ORDERING INFORMATION





(Of a unit of 0.1V within the voltage range from 1.5V to 3.3V, additional voltage versions for this product line may be available on demand with prior consultation with AIC.)

Example: AIC1733-18CVTR

ightarrow 1.8V Version, in SOT-23-5 Package & Tape & Reel

Packing Type AIC1733-18PVTR

→ 1.8V Version, in SOT-23-5 Lead Free Package & Tape & Reel Packing Type

SOT-23-5 Marking

| Part No. | Marking | Part No. | Marking | |
|--------------|---------|--------------|---------|--|
| AIC1733-15CV | EE15 | AIC1733-15PV | EE15P | |
| AIC1733-18CV | EE18 | AIC1733-18PV | EE18P | |
| AIC1733-25CV | EE25 | AIC1733-25PV | EE25P | |
| AIC1733-28CV | EE28 | AIC1733-28PV | EE28P | |
| AIC1733-30CV | EE30 | AIC1733-30PV | EE30P | |
| AIC1733-33CV | EE33 | AIC1733-33PV | EE33P | |



■ ABSOLUTE MAXIMUM RATINGS

| Supply Voltage | 12V |
|--|------------------|
| Shutdown Terminal Voltage | 12V |
| Noise Bypass Terminal Voltage | 5V |
| Operating Temperature Range | 40°C~85°C |
| Maximum Junction Temperature | 125°C |
| Storage Temperature Range | 65°C~150°C |
| Lead Temperature (Soldering, 10 sec) | 260°C |
| Thermal Resistance (Junction to Case) | SOT-23-5130°C /W |
| Thermal Resistance Junction to Ambient | SOT-23-5220°C /W |
| (Assume no ambient airflow, no heatsink) | |

Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

■ TEST CIRCUIT

Refer to TYPICAL APPLICATION CIRCUIT.



■ ELECTRICAL CHARACTERISTICS

$\underline{\text{(C$_{IN}$=1$_{\mu}F, C_{OUT}$=4.7$_{\mu}F, T_{J}$=25°C, unless otherwise specified)}$

| PARAMETER | TEST CONDITIONS | | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|-------------------------------|--|--|-------------------|------|----------------------------|------------------------------|---------------------------|
| Quiescent Current | I _{OUT} = 0mA, V _{IN} = 3.6~7V | | IQ | | 40 | 55 | μА |
| Standby Current | V _{IN} = 3.6~7V, output OFF | | I _{STBY} | | | 0.1 | μА |
| GND Pin Current | I _{OUT} = 0.1~500mA | | I _{GND} | | 30 | 50 | μА |
| Continuous Output Current | V _{IN} = 5V | | I _{OUT} | | | 500 | mA |
| Output Current Limit | V _{IN} = 5V, V _{OUT} = 0V | | I _{IL} | 500 | 600 | | mA |
| Output Voltage Tolerance | V _{IN} = 5V, no load | | V _{OUT} | -2 | | 2 | % |
| Temperature Coefficient | | | TC | | 50 | 150 | ppm/°C |
| Line Regulation | $V_{IN} = V_{OUT(TYP)} + 1V \text{ to } 7V$ | | ΔV_{LIR} | | 3 | 10 | mV |
| Load Regulation | $V_{IN} = V_{OUT} + 1.2V \text{ (Vout} \ge 2.5V)$ $V_{IN} = V_{OUT} + 1.8V \text{ (Vout} \le 2.4V)$ $I_{OUT} = 0.1 \sim 500 \text{mA}$ | | ΔV_{LOR} | | 20 | 40 | mV |
| Dropout Voltage | | $3.0V \le V_{OUT} \le 3.3V$ $2.5V \le V_{OUT} \le 2.9V$ $2.0V \le V_{OUT} \le 2.4V$ $1.5V \le V_{OUT} \le 1.9V$ | V_{DROP} | | 650 780 1100 1400 | 1050 1180 1500 1800 | mV |
| Noise Bypass Terminal Voltage | | | V_{REF} | | 1.23 | | V |
| Output Noise | $C_{BP} = 0.1 \mu F$, $f = 1 KHz$, $V_{IN} = 5 V$ | | Δn | | 0.46 | | $\frac{\mu V}{\sqrt{Hz}}$ |
| Ripple Rejection | f = 1KHz, Ripple = $0.5V_{P-P}$, $C_{BP} = 0.1\mu F$ | | RR | | 55 | | dB |



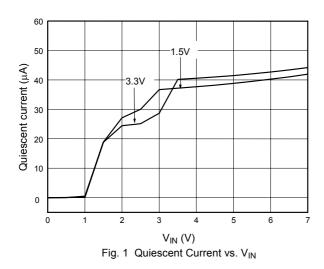
■ ELECTRICAL CHARACTERISTICS (Continued)

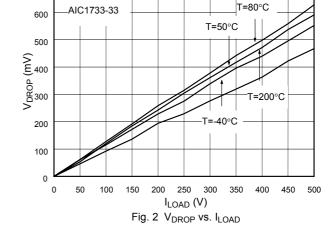
| PARAMETER | TEST CONDITIONS | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|----------------------------------|---|-----------------|------|------|------|------|
| SHUTDOWN TERMINAL SPECIFICATIONS | | | | | | |
| Shutdown Pin Current | | ISHDN | | | 0.1 | μΑ |
| Shutdown Pin Voltage (ON) | Output ON | VSHDN (ON) | 1.6 | | | V |
| Shutdown Pin Voltage (OFF) | Output OFF | VSHDN (OFF) | | | 0.6 | V |
| Shutdown Exit Delay Time | $C_{BP} = 0.1 \mu F, C_{OUT} = 1 \mu F,$ $I_{OUT} = 30 \text{mA}$ | Δt | | 300 | | μS |
| THERMAL PROTECTION | | | | | | |
| Thermal Shutdown Temperature | | T _{SD} | | 155 | | °C |

Note 1: Specifications are production tested at TA=25°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).

700

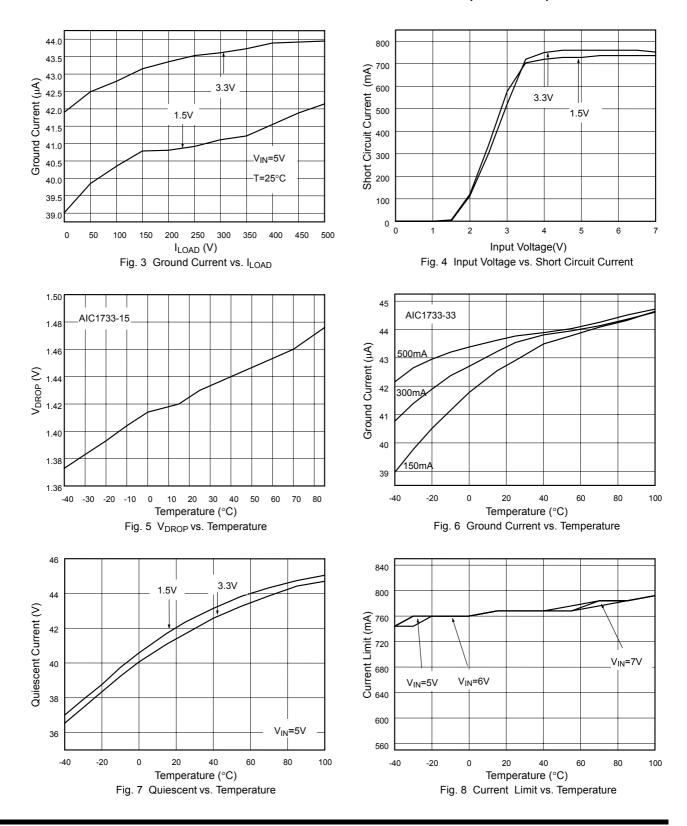
■ TYPICAL PERFORMANCE CHARACTERISTICS





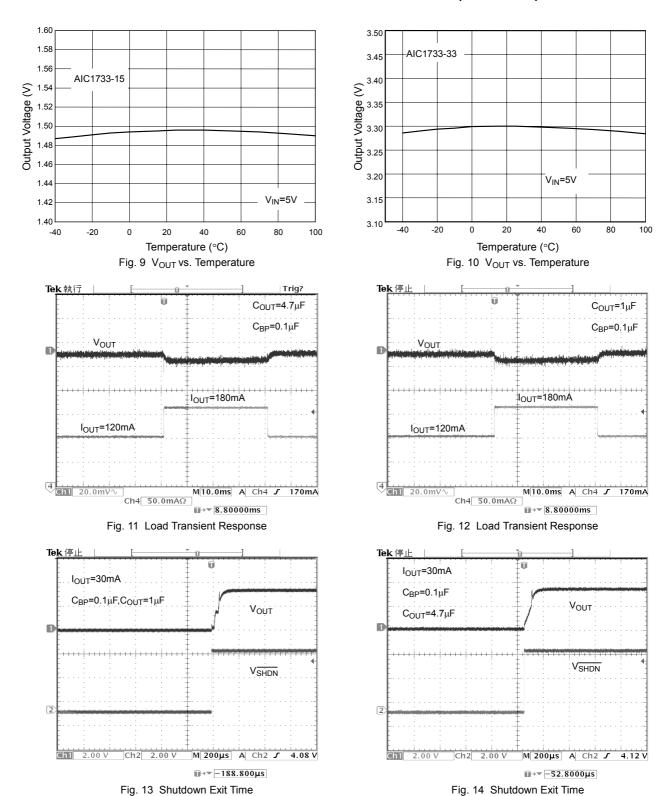


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

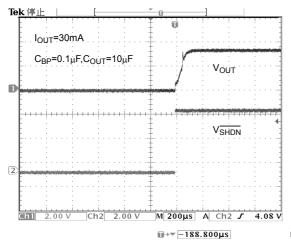


Fig. 15 Shutdown Exit Time

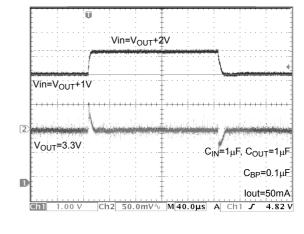


Fig. 16 Line Transient Response

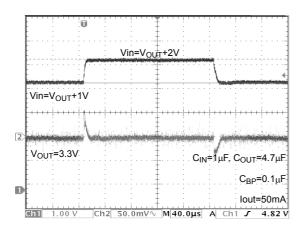


Fig. 17 Line Transient Response

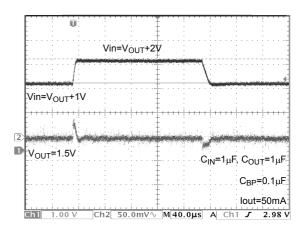


Fig. 18 Line Transient Response

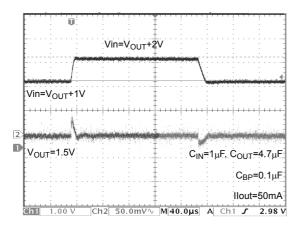
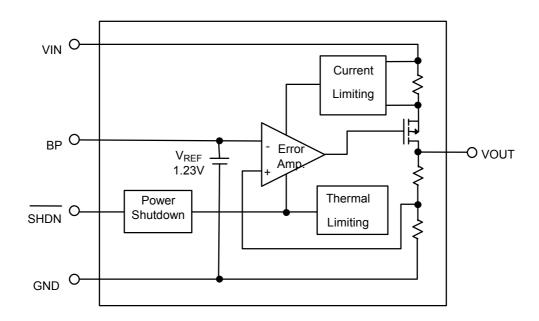


Fig. 19 Line Transient Response



BLOCK DIAGRAM



■ PIN DESCRIPTIONS

PIN 1: VIN - Power supply input pin. Bypass

with a 1μF capacitor to GND

PIN 2: GND - Ground pin.

PIN 3: SHDN - Active-Low shutdown input pin.

PIN 4: BP - Noise bypass pin. An external

bypass capacitor connected to BP pin reduces noises at the

output.

PIN 5: VOUT - Output pin. Sources up to 500

mA.

■ DETAILED DESCRIPTIONS OF TECHNICAL TERMS

DROPOUT VOLTAGE (VDROP)

The dropout voltage is defined as the difference between the input voltage and output voltage at which the output voltage drops 100mV. Below this value, the output voltage will fall as the input voltage reduces. It depends on the load current and junction temperature.

LINE REGULATION

Line regulation is the ability of the regulator to maintain a constant output voltage as the input voltage changes. The line regulation is specified as the input voltage changes from $V_{IN} = V_{OUT} + 1V$ to $V_{IN} = 7V$ and $I_{OUT} = 1$ mA.

LOAD REGULATION

Load regulation is the ability of the regulator to maintain a constant output voltage as the load current changes. A pulsed measurement with an input voltage set to $V_{IN} = V_{OUT} + V_{DROP}$ can minimize temperature effects. The load regulation is specified by the output current ranging from 0.1mA to 500mA.



CURRENT LIMIT (IIL)

AIC1733 includes a current limiting, which monitors and controls the maximum output current if the output is shorted to ground. This can protect the device from being damaged.

THERMAL PROTECTION

Thermal sensor protects device when the junction temperature exceeds T_J= +155°C. It

signals shutdown logic, turning off pass transistor and allowing IC to cool down. After the IC's junction temperature cools by 15°C, the thermal sensor will turn the pass transistor back on. Thermal protection is designed to protect the device in the event of fault conditions. For a continuous operation, do not exceed the absolute maximum junction-temperature rating of T_J= 150°C, or damage may occur to the device.

APPLICATION INFORMATION

INPUT-OUTPUT CAPACITORS

Linear regulators require input and output capacitors to maintain stability. Input capacitor at $1\mu F$ with a 4.7 μF aluminum electrolytic output capacitor is recommended. To avoid oscillation, ceramic capacitor is rejected.

NOISE BYPASS CAPACITOR

 $0.1\mu F$ bypass capacitor at BP pin reduces output voltage noise. And the BP pin has to connect a capacitor to GND.

POWER DISSIPATION

The maximum power dissipation of AIC1733 depends on the thermal resistance of its case and circuit board, the temperature difference between the die junction and ambient air, and the rate of airflow. The rate of temperature rise is greatly affected by the mounting pad configuration on the PCB, the board material, and the ambient temperature. When the IC mounting with good thermal conductivity is used, the junction temperature will be low even when

large power dissipation applies.

The power dissipation across the device is

$$P = I_{OUT} (V_{IN}-V_{OUT}).$$

The maximum power dissipation is:

$$P_{MAX} = \frac{\left(T_J - T_A\right)}{\left(R\theta_{JB} + R\theta_{BA}\right)}$$

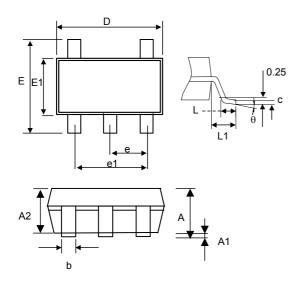
Where T_{J} - T_{A} is the temperature difference between the die junction and the surrounding air, $R\theta_{JB}$ is the thermal resistance of the package, and $R\theta_{BA}$ is the thermal resistance through the PCB, copper traces, and other materials to the surrounding air.

As a general rule, the lower temperature is, the better reliability of the device is. So the PCB mounting pad should provide maximum thermal conductivity to maintain low device temperature. GND pin performs a dual function of providing an electrical connection to ground and channeling heat away. Therefore, connecting the GND pin to ground with a large pad or ground plane would increase the power dissipation and reduce the device temperature



PHYSICAL DIMENSIONS

• SOT-23-5 (unit: mm)



| MIN | MAX | |
|----------|--|--|
| 0.95 | 1.45 | |
| 0.05 | 0.15 | |
| 0.90 | 1.30 | |
| 0.30 | 0.50 | |
| 0.08 | 0.22 | |
| 2.80 | 3.00 | |
| 2.60 | 3.00 | |
| 1.50 | 1.70 | |
| 0.95 BSC | | |
| 1.90 BSC | | |
| 0.30 | 0.60 | |
| 0.60 REF | | |
| 0° | 8° | |
| | 0.95 0.05 0.90 0.30 0.08 2.80 2.60 1.50 0.95 1.90 0.30 0.60 | |

Note:

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